TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRANSISTOR

TLP281,TLP281-4

PROGRAMMABLE CONTROLLERS AC/DC-INPUT MODULE PC CARD MODEM(PCMCIA)

TLP281 and TLP281-4 is a very small and thin coupler, suitable for surface mount assembly in applications such as PCMCIA Fax modem, programmable controllers.

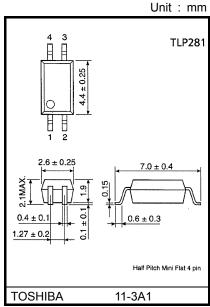
TLP281 and TLP281-4 consist of photo transistor, optically coupled to a gallium arsenide infrared emitting diode.

Collector-Emitter Voltage : 80 V (MIN)
 Current Transfer Ratio : 50% (MIN)
 Rank GB : 100% (MIN)
 Isolation Voltage : 2500 Vrms (MIN)

• UL Recognized : UL1577 , File No. E67349

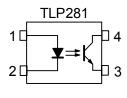
BSI Approved : BS EN 60065: 2002,

: BS EN 60950-1: 2002 Certificate No. 8143, 8144

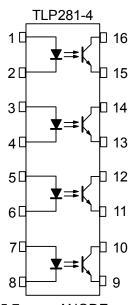


Weight: 0.05 g (typ.)

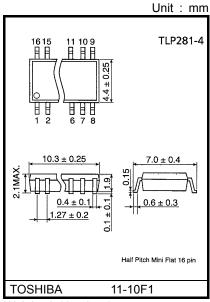
Pin Configuration (top view)



1:ANODE 2:CATHODE 3:EMITTER 4:COLLECTOR



1,3,5,7 :ANODE 2,4,6,8 :CATHODE 9,11,13,15 :EMITTER 10,12,14,16 :COLLECTOR



Weight: 0.19 g (typ.)



Current Transfer Ratio

TYPE	Classi- fication(*1)	(I _C	fer Ration (%) / I _F) = 5 V, Ta = 25°C	Marking of Classification
	neation(1)	Min	Max	
	Blank	50	600	Blank ,Y [®] ,YE,G,G [®] ,GR,B,BL,GB
	Rank Y	50	150	YE
	Rank GR	100	300	GR
	Rank BL	200	600	BL
TLP281	Rank GB	100	600	GB
	Rank YH	75	150	Y*
	Rank GRL	100	200	G
	Rank GRH	150	300	g "
	Rank BLL	200	400	В
TLP281-4	Blank	50	600	Blank , GB
1L1 201-4	Rank GB		600	GB

^{*1:} Ex. rank GB: TLP281 (GB)

(Note): Application type name for certification test, please use standard product type name, i.e. TLP281 (GB): TLP281 - 4 (GB): TLP281-4

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Absolute Maximum Ratings (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RAT	UNIT	
		STIVIBOL	TLP281	TLP281-4	UNIT
Forward Current		lF	50		mA
	Forward Current Derating	ΔI _F /°C	−0.7 (Ta≥53°C)	−0.5 (Ta≥25°C)	mA /°C
LED	Pulse Forward Current (Note 1)	I _{FP}	1		Α
	Reverse Voltage	V _R	Į.	5	V
	Junction Temperature	Tj	12	25	°C
	Collector-Emitter Voltage	V _{CEO}	8	0	V
	Emitter-Collector Voltage	V _{ECO}	7		V
S.	Collector Current	Ic	50		mA
DETECTOR	Collector Power Dissipation (1 Circuit)	P _C	150	100	mW
	Collector Power Dissipation Derating(Ta≥25°C) (1 Circuit)	ΔP _C /°C	-1.5	-1.0	mW /°C
	Junction Temperature	Tj	125		°C
Оре	erating Temperature Range	T _{opr}	−55 to 100		°C
Storage Temperature Range		T _{stg}	−55 to 125		°C
Lead Soldering Temperature		T _{sol}	260 (10s)		°C
Total Package Power Dissipation (1 Circuit)		PT	200	170	mW
Total Package Power Dissipation Derating (Ta≥25°C) (1 Circuit)		ΔP _T /°C	-2.0 -1.7		mW /°C
Isolation Voltage (Note 2)		BVS	2500(AC,1mi	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Pulse width ≤ 100µs, frequency 100Hz

(Note 2) AC, 1 minute, R.H. \leq 60%,Device considered a two terminal device : LED side pins shorted together and DETECTOR side pins shorted together.

Individual Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	V _R = 5 V	1	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	1	30	_	pF
	Collector-Emitter Breakdown Voltage	V _(BR) CEO	I _C = 0.5 mA	80	_	_	V
DETECTOR	Emitter-Collector Breakdown Voltage	V _(BR) ECO	I _E = 0.1 mA	7	_	_	٧
	Collector Dark Current	3) ICEO	V _{CE} = 48 V, Ambient Light Below (100 &x) (Note 4)	1	0.01 (2)	0.1 (10)	μΑ
	(Note 3)		V _{CE} = 48 V, Ta = 85°C Ambient Light Below (100 &x) (Note 4)		2 (4)	50 (50)	μΑ
	Capacitance (Collector to Emitter)	C _{CE}	V = 0, f = 1 MHz	_	10	_	pF

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(Note 3) Because of the construction,leak current might be increased by ambient light.

Please use photocoupler with less ambient light.

(Note 4)Irradiation to marking side using standard light bulb.

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Current Transfer Ratio	I _C / I _F	I _F = 5 mA, V _{CE} = 5 V	50	_	600	- %
		Rank GB	100	_	600	
Saturated CTR	I _C / I _{F (sat)}	IF = 1 mA, VCE = 0.4 V		60	_	%
Saluraled CTK		Rank GB	30	_	_	/0
Collector-Emitter		I _C = 2.4 mA, I _F = 8 mA	_	_	0.4	
Saturation Voltage	$V_{CE (sat)}$ $I_{C} = 0.2 \text{ mA}, I_{F} = 1 \text{ mA}$	_	0.2	_	V	
Cataration voltage		Rank GB	_	_	0.4	
Off-State Collector Current	I _{C (off)}	V _F = 0.7 V, V _{CE} = 48 V		_	10	μA

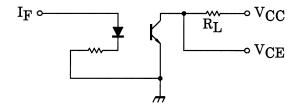
Isolation Characteristics (Ta = 25°C)

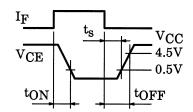
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance (Input to Output)	CS	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	R _S	V _S = 500 V, R.H.≤60%	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation Voltage		AC , 1 minute	2500	_	_	Vrms
	BV_S	AC , 1 second,in OIL 5000	5000	_	VIIIIS	
		DC , 1 minute, in OIL	_	5000	_	Vdc

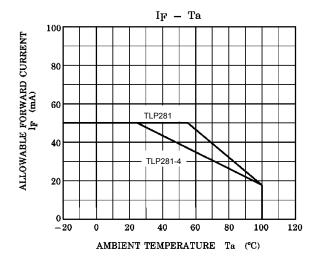
Switching Characteristics (Ta = 25°C)

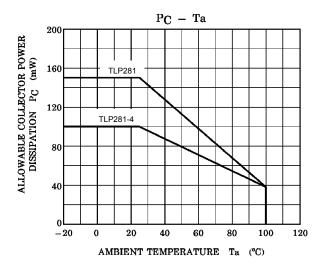
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Rise Time	t _r		_	2	_	
Fall Time	t _f	V _{CC} = 10 V, I _C = 2 mA	_	3	_	μs
Turn-On Time	t _{on}	$R_L = 100\Omega$	_	3	_	μδ
Turn-Off Time	t _{off}		_	3	_	
Turn-On Time	t _{ON}	$R_L = 1.9 \text{ k}\Omega \text{ (Fig.1)}$ $V_{CC} = 5 \text{ V, I}_F = 16 \text{ mA}$	_	2	_	
Storage Time	ts		_	25	_	μs
Turn-Off Time	toff		_	40	_	

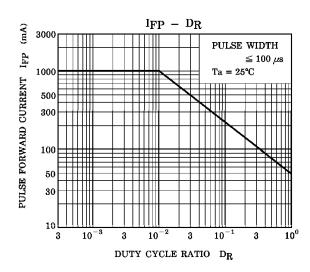
(Fig.1)SWITCHING TIME TEST CIRCUIT

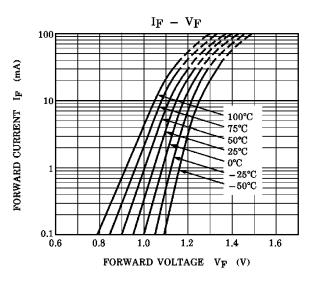


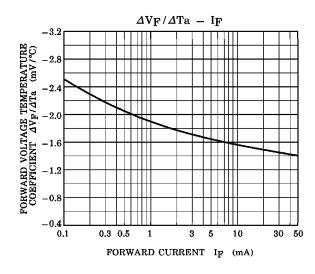


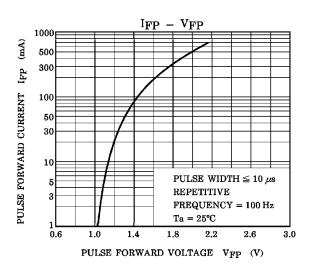




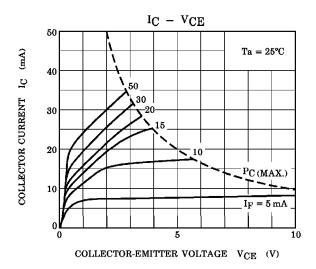


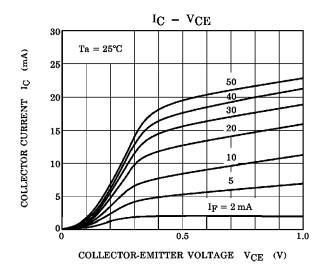


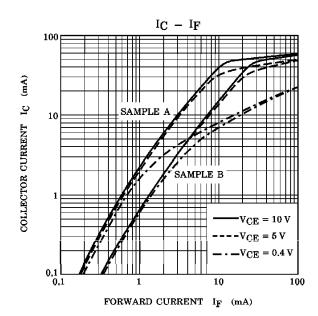


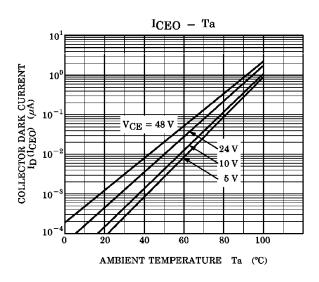


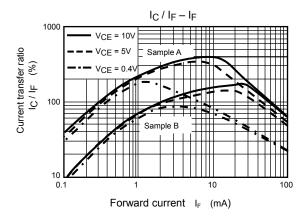
^{*}The above graphs show typical characteristic.



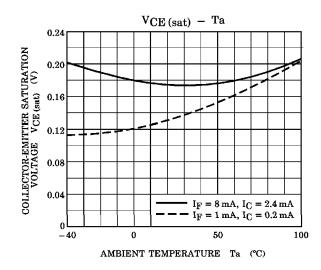


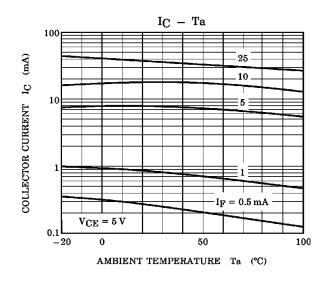


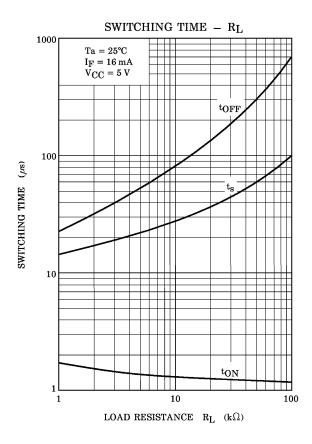


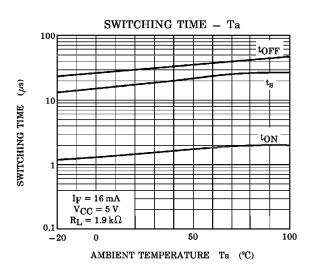


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